

Schottky-Barrier Diodes (SBD)

1 in one-package

Device type	SMD	Maximum rating V _{RRM} Volts	I _{F(AV)} *1 Amps.	I _{FSM} *2 Amps.	Thermal rating T _j and T _{stg} °C	Characteristics(T _a =25°C) V _{FM} Max. Volts	I _{RRM} *3 Max.mA	R _{th(j-c)} °C/W	Package	Net mass Grams
ERA82-004		40	0.6(T _a =60°C)	25	-40 to +150	0.55(I _F =0.6A)	1		Lead-1	0.18
SC802-04	SMD	40	1.0(T _I =115°C) *5	40	-40 to +150	0.55(I _F =1.0A)	2		SC	0.06
SC802-06	SMD	60	1.0(T _I =111°C) *5	30	-40 to +150	0.58(I _F =1.0A)	2		SC	0.06
SC802-09	SMD	90	1.0(T _I =110°C) *5	30	-40 to +150	0.85(I _F =1.0A)	2		SC	0.06
ERA83-004		40	1.0(T _I =115°C)	50	-40 to +150	0.55(I _F =1.0A)	2		Lead-1	0.18
ERA83-006		60	1.0(T _I =111°C)	30	-40 to +150	0.58(I _F =1.0A)	2		Lead-1	0.18
ERA81-004		40	1.0(T _a =25°C)	50	-40 to +150	0.55(I _F =1.0A)	2		Lead-2	0.22
ERA84-009		90	1.0(T _a =25°C) *6	30	-40 to +150	0.9 (I _F =1.0A)	1		Lead-2	0.22
ERA85-009		90	1.0(T _I =110°C)	30	-40 to +150	0.82(I _F =1.0A)	1		Lead-1	0.18
CB803-03		30	2.0(T _I =133°C)	80	-40 to +150	0.47(I _F =1.5A)	5		Lead-3	0.3
ERB83-004		40	2.0(T _I =130°C)	100	-40 to +150	0.55(I _F =2.0A)	5		Lead-3	0.3
ERB83-006		60	2.0(T _I =104°C)	60	-40 to +150	0.58(I _F =2.0A)	5		Lead-3	0.3
ERB81-004		40	2.0(T _I =130°C)	100	-40 to +150	0.55(I _F =2.0A)	5		Lead-4	0.5
ERB84-009		90	2.0(T _a =25°C) *7	60	-40 to +150	0.9 (I _F =2.0A)	2		Lead-4	0.5
ED807-03		30	3.0(T _I =134°C)	120	-40 to +150	0.47(I _F =3.0A)	5		Lead-7	1.2
ERC81-004		40	3.0(T _I =130°C)	120	-40 to +150	0.55(I _F =3.0A)	5		Lead-7	1.2
ERC81-006		60	3.0(T _I =104°C)	80	-40 to +150	0.58(I _F =3.0A)	5		Lead-7	1.2
ERC84-009		90	3.0(T _I =85°C)	120	-40 to +150	0.8 (I _F =3.0A)	5		Lead-7	1.2
ERC81S-004		40	5.0(T _I =25°C)	120	-40 to +150	0.55 (I _F =5.0A)	5		Lead-7	1.2
KS826S04	SMD	40	5.0(T _c =92°C)	80	-40 to +150	0.55(I _F =5.0A)	5	10	K-pack(S)	0.6
ERC80-004		40	5.0(T _c =102°C)	120	-40 to +150	0.55(I _F =5.0A)	5	5.0	TO-220AB	2.0
YG811S04R		40	5.0(T _c =102°C)	120	-40 to +150	0.55(I _F =5.0A)	5	5.0	TO-220F15	2.3
YG811S06R		60	5.0(T _c =100°C)	80	-40 to +150	0.59(I _F =5.0A)	5	5.0	TO-220F15	2.3
YG811S09R		90	5.0(T _c =85°C)	80	-40 to +150	0.9 (I _F =4.0A)	5	5.0	TO-220F15	2.3
ERC62-004		45	10 (T _c =110°C)	250	-40 to +150	0.6 (I _F =10A)	2	2.0	TO-220AB	2.0
ERC62M-004		45	10 (T _c =101°C)	250	-40 to +150	0.6 (I _F =10A)	2	2.5	TO-220F17	2.3
ERD80-004		40	15 (T _c =100°C)	250	-40 to +150	0.55(I _F =12.5A)	10	2.0	TO-3P	5.5
ERD81-004		40	15 (T _c =100°C)	250	-40 to +125	0.55(I _F =15A)	100*4		Power M5R	5.5
ERE81-004		40	30 (T _c =100°C)	600	-40 to +125	0.55(I _F =30A)	200*4		Power M6R	12
ERG81-004		40	60 (T _c =90°C)	850	-40 to +125	0.55(I _F =50A)	300*4		Power M8R	25
ERG81A-004		40	60 (T _c =90°C)	850	-40 to +125	0.55(I _F =50A)	300*4		Power M8R	25

() Conditions

*1 Resistive load *2 Sine wave, 10ms *3 V_R=V_{RRM}

*4 T_j=125°C

*5 Mounted to fabric base epoxy resin printed circuits (land 15 x 15mm)

*6 P.C board mounting (land 10 x 10mm)

*7 Mounted Cu fins (20 x 20mm) on the both leads

Letter symbols

V_{RRM} Repetitive peak reverse voltage
V_{RSM} Non-repetitive peak reverse voltage
I_O Average output current
I_{FSM} Surge current
T_j Junction temperature
T_a Ambient temperature
T_c Case temperature

T_{stg} Storage temperature
V_{FM} Forward voltage
I_{RRM} Reverse current
t_{rr} Reverse recovery time
R_{th(j-c)} Thermal resistance (Junction to case)
T_I Lead temperature
I_{F(AV)} Average forward current



Schottky-Barrier Diodes (SBD)

2 in one-package

Device type	SMD	Maximum rating			Thermal rating	Characteristics(Ta=25°C)			Package	Net mass
		V _{RRM} Volts	I _O *1 Amps.	I _{FSM} *2 Amps.	T _J and T _{stg} °C	V _{FM} Max. Volts	I _{RRM} *3 Max.mA	R _{th(j-c)} °C/W		Grams
KS823C03	SMD	30	5.0(Tc=87°C)	60	-40 to +150	0.47(I _F =2.5A)	5.0	10	K-pack(S)	0.6
KS823C04	SMD	40	5.0(Tc=87°C)	60	-40 to +150	0.55(I _F =2.5A)	5.0	10	K-pack(S)	0.6
KP823C03		30	5.0(Tc=87°C)	60	-40 to +150	0.47(I _F =2.5A)	5.0	10	K-pack(P)	0.6
KP823C04		40	5.0(Tc=87°C)	60	-40 to +150	0.55(I _F =2.5A)	5.0	10	K-pack(P)	0.6
TP801C04		40	5.0(Tc=103°C)	100	-40 to +150	0.55(I _F =2.0A)	5.0	5.0	T-pack(P)	1.6
TP801C06		60	5.0(Tc=103°C)	60	-40 to +150	0.58(I _F =2.0A)	5.0	5.0	T-pack(P)	1.6
ESAB82-004		40	5.0(Tc=103°C)	100	-40 to +150	0.55(I _F =2.0A)	5.0	5.0	TO-220AB	2.0
YG801C04R		40	5.0(Tc=103°C)	100	-40 to +150	0.55(I _F =2.0A)	5.0	5.0	TO-220F15	2.3
YG801C06R		60	5.0(Tc=103°C)	60	-40 to +150	0.58(I _F =2.0A)	5.0	5.0	TO-220F15	2.3
YG801C09R		90	5.0(Tc=95°C)	60	-40 to +150	0.9 (I _F =2.0A)	2.0	5.0	TO-220F15	2.3
YG801C10R		100	5.0(Tc=117°C)	60	-40 to +150	0.8 (I _F =1.5A)	0.7	2.5	TO-220F15	2.3
ESAB85-009		90	5.0(Tc=95°C)	60	-40 to +150	0.9 (I _F =2.0A)	2.0	5.0	TO-220AB	2.0
YG831C03R		30	6.0(Tc=127°C)	90	-40 to +150	0.45(I _F =2.0A)	5.0	5.0	TO-220F15	2.3
YG831C04R		40	6.0(Tc=122°C)	80	-40 to +150	0.53(I _F =2.0A)	2.0	5.0	TO-220F15	2.3
KS883C02	SMD	20	7.0(Tc=89°C)	60	-40 to +150	0.39(I _F =2.5A)	10.0	10.0	K-pack (S)	0.6
KP883C02		20	7.0(Tc=89°C)	60	-40 to +150	0.39(I _F =2.5A)	10.0	10.0	K-pack (P)	0.6
YG881C02R		20	8.0(Tc=102°C)	80	-40 to +150	0.39(I _F =2.0A)	10.0	5.0	TO-220F15	2.3
TS802C04	SMD	40	10 (Tc=97°C)	120	-40 to +150	0.55(I _F =4.0A)	5.0	3.0	T-pack(S)	1.6
TS802C06	SMD	60	10 (Tc=96°C)	80	-40 to +150	0.58(I _F =4.0A)	5.0	3.0	T-pack(S)	1.6
TS802C09	SMD	90	10 (Tc=92°C)	80	-40 to +150	0.9 (I _F =4.0A)	5.0	3.0	T-pack(S)	1.6
TP802C04		40	10 (Tc=97°C)	120	-40 to +150	0.55(I _F =4.0A)	5.0	3.0	T-pack(P)	1.6
TP802C06		60	10 (Tc=96°C)	80	-40 to +150	0.58(I _F =4.0A)	5.0	3.0	T-pack(P)	1.6
TP802C09		90	10 (Tc=92°C)	80	-40 to +150	0.9 (I _F =4.0A)	5.0	3.0	T-pack(P)	1.6
ESAC82-004		40	10 (Tc=97°C)	120	-40 to +150	0.55(I _F =4.0A)	5.0	3.0	TO-220AB	2.0
YG802C03R		30	10 (Tc=102°C)	120	-40 to +150	0.47(I _F =4.0A)	5.0	3.5	TO-220F15	2.3
YG802C04R		40	10 (Tc=95°C)	120	-40 to +150	0.55(I _F =4.0A)	5.0	3.5	TO-220F15	2.3
YG802C06R		60	10 (Tc=92°C)	80	-40 to +150	0.58(I _F =4.0A)	5.0	3.5	TO-220F15	2.3
YG802C09R		90	10 (Tc=87°C)	80	-40 to +150	0.9 (I _F =4.0A)	5.0	3.5	TO-220F15	2.3
YG802C10R		100	10 (Tc=102°C)	80	-40 to +150	0.8 (I _F =3.0A)	1.2	2.5	TO-220F15	2.3
ESAC85-009		90	10 (Tc=92°C)	80	-40 to +150	0.9 (I _F =4.0A)	5.0	3.0	TO-220AB	2.0
YG832C03R		30	12 (Tc=118°C)	120	-40 to +150	0.45 (I _F =4.0A)	5.0	3.5	TO-220F15	2.3
YG832C04R		40	12 (Tc=112°C)	120	-40 to +150	0.53 (I _F =4.0A)	3.0	3.5	TO-220F15	2.3
ESAC61-004		40	12 (Tc=100°C)	120	-40 to +150	0.6 (I _F =6.0A)	5.0	2.0	TO-3P	5.5
YG882C02R		20	16 (Tc=93°C)	120	-40 to +150	0.39 (I _F =4.0A)	10	3.5	TO-220F15	2.3
ESAC87-009		90	16 (Tc=90°C)	100	-40 to +150	0.9 (I _F =6.0A)	10	1.5	TO-3P	5.5
ESAC87M-009		90	16 (Tc=90°C)	100	-40 to +150	0.9 (I _F =6.0A)	10	2.0	TO-3PF	6.0

() Conditions

*1 Square wave duty 1/2 (Average forward current of centertap full wave connection)

*2 Sine wave, 10ms *3 V_R=V_{RRM}

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2 in one-package

Device type	SMD	Maximum rating V _{RRM} Volts	I _O * ¹ Amps.	I _{FSM} * ² Amps.	Thermal rating T _j and T _{stg} °C	Characteristics(T _a =25°C)			Package	Net mass Grams
						V _{FM} Max. Volts	I _{RRM} * ³ Max.mA	R _{th(j-c)} °C/W		
TS805C04	SMD	40	20 (T _c =92°C)	120	-40 to +150	0.6 (I _F =10A)	15	2.0	T-pack(S)	1.6
TS805C06	SMD	60	20 (T _c =118°C)	80	-40 to +150	0.58(I _F =8.0A)	15	2.0	T-pack(S)	1.6
TP805C04		40	20 (T _c =92°C)	120	-40 to +150	0.6 (I _F =10A)	15	2.0	T-pack(P)	1.6
ESAC83-004		40	20 (T _c =95°C)	120	-40 to +150	0.55(I _F =8.0A)	15	1.5	TO-3P	5.5
ESAC83M-004		40	20 (T _c =79°C)	120	-40 to +150	0.55(I _F =8.0A)	15	2.5	TO-3PF	6.0
ESAC83M-006		60	20 (T _c =78°C)	120	-40 to +150	0.58(I _F =8.0A)	15	2.5	TO-3PF	6.0
YG805C04R		40	20 (T _c =83°C)	120	-40 to +150	0.6 (I _F =10A)	15	2.5	TO-220F15	2.3
YG805C06R		60	20 (T _c =108°C)	80	-40 to +150	0.58(I _F =8.0A)	15	2.5	TO-220F15	2.3
YG805C10R		100	20 (T _c =91°C)	100	-40 to +150	0.8 (I _F =5.0A)	2.5	2.5	TO-220F15	2.3
ESAC63-004		45	20 (T _c =92°C)	120	-40 to +150	0.6 (I _F =10A)	15	2.0	TO-220AB	2.0
YG835C04R		40	22 (T _c =95°C)	120	-40 to +150	0.53(I _F =8.0A)	6.0	2.5	TO-220F15	2.3
YG835C03R		30	25 (T _c =99°C)	120	-40 to +150	0.45(I _F =6.0A)	15	2.5	TO-220F15	2.3
ESAD85-009		90	25 (T _c =90°C)	150	-40 to +150	0.9 (I _F =10A)	20	1.2	TO-3P	5.5
ESAD85M-009		90	25 (T _c =76°C)	150	-40 to +150	0.9 (I _F =10A)	20	1.7	TO-3PF	6.0
YG885C02R		20	30 (T _c =80°C)	120	-40 to +150	0.39(I _F =8.0A)	30	2.5	TO-220F15	2.3
PA886C02		20	30 (T _c =85°C)	250	-40 to +125	0.4 (I _F =12.5A)	50	1.2	TO-3P	5.5
PA806C03		30	30 (T _c =100°C)	250	-40 to +150	0.47(I _F =12.5A)	20	1.2	TO-3P	5.5
TS808C04	SMD	40	30 (T _c =93°C)	250	-40 to +150	0.55(I _F =12.5A)	20	1.2	T-pack(S)	1.6
TS808C06	SMD	60	30 (T _c =88°C)	200	-40 to +150	0.58(I _F =12.5A)	20	1.2	T-pack(S)	1.6
YG808C10R		100	30 (T _c =80°C)	180	-40 to +150	0.8 (I _F =10A)	20	2.0	TO-220F15	2.3
ESAD83-004		40	30 (T _c =90°C)	250	-40 to +150	0.55(I _F =12.5A)	20	1.2	TO-3P	5.5
ESAD83-006		60	30 (T _c =90°C)	200	-40 to +150	0.58(I _F =12.5A)	20	1.2	TO-3P	5.5
ESAD83M-004		40	30 (T _c =79°C)	250	-40 to +150	0.55(I _F =12.5A)	20	1.7	TO-3PF	6.0
ESAD83M-006		60	30 (T _c =75°C)	200	-40 to +150	0.58(I _F =12.5A)	20	1.7	TO-3PF	6.0
ESAE83-004		40	60 (T _c =84°C)	500	-40 to +150	0.55(I _F =25A)	50	0.75	TO-3P	5.5
ESAE83-006		60	60 (T _c =71°C)	500	-40 to +150	0.58(I _F =25A)	50	0.75	TO-3P	5.5

() Conditions

*¹ Square wave duty 1/2 (Average forward current of centertap full wave connection)

*² Sine wave, 10ms *³ V_R=V_{RRM}